IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

re Patent Application of

Gu-Sung KIM, et al.

Examiner: Long Pham

Serial No. 10/073,173

Art Unit: 2822

Filed: February 13, 2002

For:

WAFER LEVEL PACKAGE WITH AIR PADS AND MANUFACTURING

METHOD THEREOF

PETITION FOR EXTENSION OF TIME **UNDER 37 C.F.R. § 1.136**

Commissioner for Patents Washington, D.C. 20231

Sir:

It is respectfully requested that an extension of time for the period indicated below be granted in accordance with the provisions of 37 C.F.R. §1.136 to take the action required in the application identified in caption, as reflected by the papers submitted herewith.

> X First Month \$110 (\$ 55)* \$290 (\$145)* Second Month _Third Month \$520 (\$260)* _Fourth Month \$520 (\$260)*

*(Small Entity)TOTAL FEE: \$110.00

_Fifth Month

The Commissioner is hereby authorized to charge the necessary extension fees to our Deposit Account No. 5-01645.

Respectfully submitted,

\$500 (\$250)*

December 16, 2002

Date

Eugene M. Lee

Registration No. 32,039

Richard A. Sterba

Registration No. 43,162

LEE & STERBA P.C. 1101 Wilson Boulevard, Suite 2000 Arlington, Virginia 22209 Telephone: (703) 525-0978

19/1000 EMMYLES 00000120 501645 10073173

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